

### **AMENDMENTS TO THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application:

#### **Listing of Claims:**

1. (Currently Amended) A heat-dissipating fan module of an electronic apparatus, comprising:  
a casing having an opening, said opening having ~~a~~ an airflow guiding device formed integrally therewith and along an edge thereof metal material of the opening, wherein material that is removed to form said opening forms the guiding device by bending the material; and  
a heat-dissipating fan fixed into one side of said casing and correspondingly disposed on said opening.
2. (Original) The heat-dissipating fan module according to claim 1 wherein said guiding device is a metal material disposed on said edge portion of said opening, extended from said edge of said opening, and inclined toward the axis of the opening.
3. (Original) The heat-dissipating fan module according to claim 1 wherein said casing and said guiding device are disposed to form a particular angle.
4. (Original) The heat-dissipating fan module according to claim 3 wherein said particular angle is substantially 5 to 90 degrees.
5. (Original) The heat-dissipating fan module according to claim 1 wherein said heat-dissipating fan is a fan without a frame.
6. (Original) The heat-dissipating fan module according to claim 1 wherein said casing further comprises a reticular portion integrally formed therewith and disposed at the corresponding position of said opening.
7. (Original) The heat-dissipating fan module according to claim 1 further comprising a reticular plate, wherein said reticular plate is separably fixed to one side of said casing for covering said opening.

8. (Original) The heat-dissipating fan module according to claim 1 wherein said electronic apparatus is a power supply.

9-18. (Cancelled)